JACOBSON HOLMAN

PROFESSIONAL LIMITED LIABILITY COMPANY

400 SEVENTH STREET, N. W.

WASHINGTON, D. C. 20004

(202) 638-6666

YOON S. HAM Direct: (202)662-8483 yham@jphs.com

JACOBSON HOLMAN STERN

OF COUNSEL MARVIN R. STERN NATHANIEL A. HUMPHRIES

TELEFAX: (202) 393-5350 (202) 393-535

E-MAIL: IP@JPHS.COM INTERNET: WWW.JPHS.COM

BAR OTHER THAN DC

June 25, 2001

Atty. Docket No.: <u>11349-P66792US0</u>

CUSTOMER NUMBER: 00136

Honorable Commissioner for Patents Washington, D.C. 20231

sir:

HARVEY B. JACOBSON, JR. JOHN CLARKE HOLMAN SIMOR L. MOSKOWITZ ALLEN S. MELSER

ALLEN S. MELSER
MICHAEL R. SLOBASKY
MARSHA G. GENTNER
JONATHAN L. SCHERER
IRWIN M. AISENBERG
GEORGE W. LEWIS
WILLIAM E. PLAYER
YOON S. HAM
PHILIP L. O'NEILL
LINDA J. SHAPIRO
LEESA N. WEISS
SUZIN C. BAILEY*
MATTHEW J. CUCCIAS

MATTHEW J. CUCCIAS DANIEL K. DORSEY MENICA LEWIS*

895 5

Œ

M

겅

Transmitted herewith for filing is the patent application in the names

HONG, Kwon of Ichon-Shi, Republic of Korea; and CHOI, Hyung-Bok of Ichon-Shi, Republic of Korea,

for SEMICONDUCTOR MEMORY DEVICE HAVING PLUG CONTACTED TO CAPACITOR The application ELECTRODE AND METHOD FOR FABRICATING THE SAME. comprises a $\underline{19}$ -page specification including $\underline{18}$ claims (3 independents) and Abstract, 10 sheets of drawings (Figs. 1A-3I).

Also accompanying this application for filing is:

A certified copy of Korean Application No. 2000-37007, filed June 30, 2000, the priority of which is claimed under 35 U.S.C. §119.

This application is being filed under 37 C.F.R. §1.53 (without Declaration or Filing Fee). The required Declaration and Filing Fee will be filed subsequently.

Should a fee be necessary to obtain a filing date, the Commissioner is hereby authorized to charge payment of any fees set forth in §§1.17 or 1.492 during the pendency of this application, or credit any overpayment, to Deposit Account No. 06-1358. A duplicate copy of this sheet is enclosed.

Respectfully submitted,

JACOBSON HOLMAN, PLLC

Enclosures YSH:ecl

Ham, Reg. No. 45,307

M TI. N U

يتحز

Ø

ŭ

Ħ

Ĭ